

## CDR31BX222BMUP

Aliases (C0805N222M1XPL, CDR31BX222BMZP, CDR31BX222BMWP)

SMD Mil PRF55681, Ceramic, 2200 pF, 20%, 100 VDC, BP, Ceramic Chips, MIL PRF 55681 Established Reliability, P (0.1%/1000 Hrs), 0805



Click [here](#) for the 3D model.

### Dimensions

|           |                 |
|-----------|-----------------|
| Chip Size | 0805            |
| L         | 2mm +/-0.2mm    |
| W         | 1.25mm +/-0.2mm |
| T         | 1.3mm MAX       |
| B         | 0.5mm +/-0.2mm  |

### Packaging Specifications

|                    |           |
|--------------------|-----------|
| Packaging          | Bulk, Bag |
| Packaging Quantity | 1         |

### General Information

|                         |  |
|-------------------------|--|
| Series                  | SMD Mil PRF55681   |
| Style                   | SMD Chip   |
| Description             | Ceramic Chips, MIL PRF 55681 Established Reliability   |
| RoHS                    | No   |
| Prop 65                 | <b>⚠ WARNING:</b> Cancer and reproductive harm - <a href="http://www.p65warnings.ca.gov">http://www.p65warnings.ca.gov</a> . |
| Termination             | Lead (SnPb)  |
| Failure Rate            | P (0.1%/1000 Hrs)  |
| Testing and Reliability | MIL-PRF-55681  |
| Qualifications          | MIL-PRF-55681  |
| AEC-Q200                | No   |
| Shelf Life              | 78 Weeks   |
| MSL                     | 1  |

### Specifications

|                                 |            |
|---------------------------------|------------|
| Capacitance                     | 2200 pF    |
| Capacitance Tolerance           | 20%        |
| Voltage DC                      | 100 VDC    |
| Dielectric Withstanding Voltage | 250 VDC    |
| Temperature Range               | -55/+125°C |
| Temperature Coefficient         | BP         |
| Dissipation Factor              | 0.15%      |
| Insulation Resistance           | 100 GOhms  |